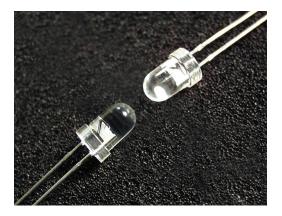


# C503C-WAS/WAN: 5-mm Round White LEDs



#### **PRODUCT DESCRIPTION**

Round LEDs offer superior light output • for excellent readability in sunlight and dependable performance. They provide • extremely stable light output over long periods of time.

These lamps are made with an advanced optical-grade epoxy offering superior hightemperature and high-moisture-resistance performance in lighting and illumination . applications. This product utilizes an epoxy containing a UV inhibitor. It therefore provides a UV resistance and can be used • in outdoor applications. •

# FEATURES

- Size (mm): 5
- Color Temperatures: Cool White : Min . (4600K) / Typical (9000K)
- Luminous Intensity (mcd) C503C-WAS/WAN: (20150-46100)
- Viewing angles: 15°: C503C-WAS/WAN
- Lead Free
- RoHS Compliant

#### **APPLICATIONS**

- Torch
- Channel Letter
- Retail Display Lighting

# ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Items	Symbol	Absolute Maximum Rating	Unit	
Forward Current	l <sub>F</sub>	30	mA	
Peak Forward Current Note 1	I <sub>FP</sub>	100	mA	
Reverse Voltage	V <sub>R</sub>	5	V	
Power Dissipation	P <sub>D</sub>	120	mW	
Operation Temperature	T <sub>opr</sub>	-40 ~ +95	°C	
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C	
Lead Soldering Temperature	T <sub>sol</sub>	Max. 260°C for 3 sec. max. (3 mm from the base of the epoxy bulb)		

#### Note:

1. Pulse width  $\leq 0.1$  msec, duty  $\leq 1/10$ .

# **TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS (T<sub>A</sub> = 25^{\circ}C)**

Characteristics	Color	Symbol	Condition	Unit	Minimum	Typical	Maximum
Forward Voltage	WAS/WAN	V <sub>F</sub>	l <sub>F</sub> = 20 mA	V		3.2	4.0
Reverse Current	WAS/WAN	I <sub>R</sub>	V <sub>R</sub> = 5 V	μA			100
Luminous Intensity	WAS/WAN	I <sub>v</sub>	I <sub>F</sub> = 20 mA	mcd	20150	35000	
Chromaticity		х	I <sub>F</sub> = 20 mA			0.2895	
Coordinates	WAS/WAN	У	I <sub>F</sub> = 20 mA			0.2905	
50% Power Angle	WAS/WAN	201⁄2	l <sub>F</sub> = 20 mA	deg		15	

\* Continuous reverse voltage can cause LED damage.



#### **INTENSITY BIN LIMIT**

Cool White (20 mA) - C503C-WAS/WAN					
Bin Code	Min.(mcd)	Max.(mcd)			
Bb	20150	23500			
Ca	23500	28200			
Cb	28200	32900			
Da	32900	39500			
Db	39500	46100			

\* Tolerance of measurement of luminous intensity is ±15%

# **VOLTAGE BIN LIMIT**

Cool White (20 mA) - C503C-WAS/WAN					
Bin Code	Min. (V) Max. (V)				
27	2.8	3.0			
28	3.0	3.2			
29	3.2	3.4			
2a	3.4	3.6			
2b	3.6	3.8			
2c	3.8	4.0			

\* Tolerance of measurement of voltage is ±0.05V

## **COLOR BIN LIMIT**

#### Cool White (20 mA) - C503C-WAS/WAN

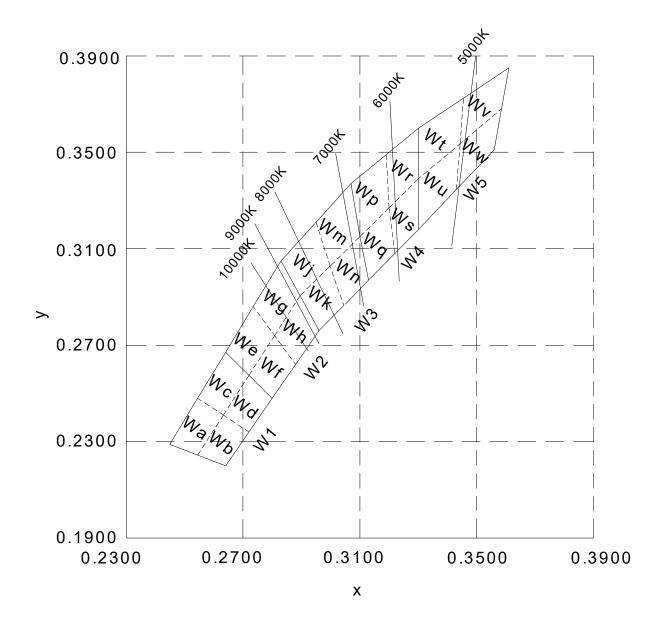
		,	у	
Bin Code	Sub-bin	x		
		0.2545	0.2480	
	14/-	0.2633	0.2410	
	Wa	0.2545	0.2245	
		0.2450	0.2290	
		0.2633	0.2410	
	Wb	0.2720	0.2340	
	UVV	0.2640	0.2200	
W1		0.2545	0.2245	
VV I		0.2545	0.2480	
	Wc	0.2640	0.2670	
	VVC	0.2720	0.2575	
		0.2633	0.2410	
	Wd	0.2633	0.2410	
		0.2720	0.2575	
		0.2800	0.2480	
		0.2720	0.2340	
		0.2640	0.2670	
	We	0.2735	0.2860	
	we	0.2808	0.2740	
		0.2720	0.2575	
		0.2720	0.2575	
	Wf	0.2808	0.2740	
	VVI	0.2880	0.2620	
W2		0.2800	0.2480	
V V Z		0.2735	0.2860	
	Wg	0.2830	0.3050	
	vvg	0.2895	0.2905	
		0.2808	0.2740	
		0.2808	0.2740	
	Wh	0.2895	0.2905	
	vvn	0.2960	0.2760	
		0.2880	0.2620	

Bin Code	Sub-bin	x	У
	W	0.2830	0.3050
		0.2950	0.3210
	Wj	0.2998	0.3028
		0.2895	0.2905
		0.2895	0.2905
	Wk	0.2998	0.3028
	VVIN	0.3045	0.2865
W3		0.2960	0.2760
VV3		0.2950	0.3210
	Wm	0.3070	0.3370
	VVIII	0.3100	0.3150
		0.2998	0.3028
	Wn	0.2998	0.3028
		0.3100	0.3150
		0.3130	0.2970
		0.3045	0.2865
		0.3070	0.3370
	Wp	0.3185	0.3485
		0.3200	0.3270
		0.3100	0.3150
		0.3100	0.3150
	Wq	0.3200	0.3270
	٧٧٩	0.3215	0.3075
W4		0.3130	0.2970
**-		0.3185	0.3485
	Wr	0.3300	0.3600
	VVI	0.3300	0.3390
		0.3200	0.3270
		0.3200	0.3270
	We	0.3300	0.3390
	Ws	0.3300	0.3180
		0.3215	0.3075

Bin Code	Sub-bin	x	у
	Wt	0.3300	0.3600
		0.3455	0.3725
	VVL	0.3443	0.3535
		0.3300	0.3390
		0.3300	0.3390
	Wu	0.3443	0.3535
		0.3430	0.3345
W5		0.3300	0.3180
VV 5	WS Wv Ww	0.3455	0.3725
		0.3610	0.3850
		0.3585	0.3680
		0.3443	0.3535
		0.3443	0.3535
		0.3585	0.3680
		0.3560	0.3510
		0.3430	0.3345

\* Tolerance of measurement of the color coordinates is  $\pm 0.01$ 

**CIE CHROMATICITY DIAGRAM** 



CLD-CT1098 REV 12



## **ORDER CODE TABLE**

Color Viewing Angle	Kit Number	Luminous Intensity (mcd)		Color Bin Code		Otom de ff	
	Kit Number	Min.	Max.	Color Bin Code	Package	Standoff	
		C503C-WAS-CBbDb151	20150	46100	W1,W2,W3,W4,W5	Bulk	Yes
		C503C-WAS-CBbDb231	20150	46100	W2,W3	Bulk	Yes
		C503C-WAS-CCaDb231	23500	46100	W2,W3	Bulk	Yes
		C503C-WAN-CBbDb151	20150	46100	W1,W2,W3,W4,W5	Bulk	No
	Cool White 15°	C503C-WAN-CBbDb231	20150	46100	W2,W3	Bulk	No
Cool White		C503C-WAN-CCaDb231	23500	46100	W2,W3	Bulk	No
COOLANIIII		C503C-WAS-CBbDb152	20150	46100	W1,W2,W3,W4,W5	Ammo	Yes
		C503C-WAS-CBbDb232	20150	46100	W2,W3	Ammo	Yes
		C503C-WAS-CCaDb232	23500	46100	W2,W3	Ammo	Yes
		C503C-WAN-CBbDb152	20150	46100	W1,W2,W3,W4,W5	Ammo	No
		C503C-WAN-CBbDb232	20150	46100	W2,W3	Ammo	No
		C503C-WAN-CCaDb232	23500	46100	W2,W3	Ammo	No

Notes:

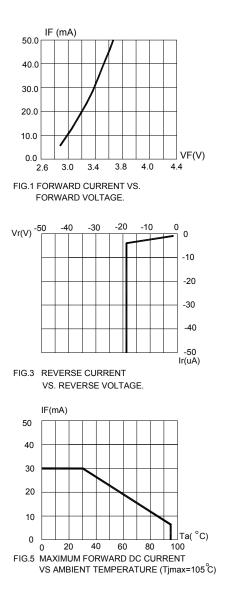
• The above kit numbers represent order codes that include multiple intensity-bin and color-bin codes. Only one intensity-bin code and one color-bin code will be shipped on each bulk. Single intensity-bin code and single color-bin codes will not be orderable.

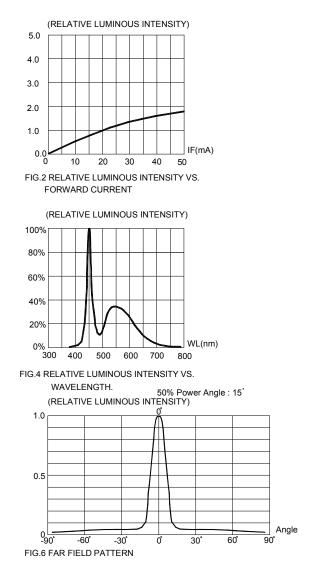
• Please refer to the HB LED Lamp Reliability Test Standards document for reliability test conditions.

• Please refer to the HB LED Lamp Soldering & Handling document for information about how to use this LED product safely.

#### **GRAPHS**

The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.



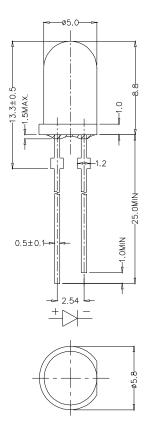


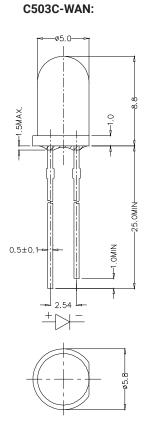


# **MECHANICAL DIMENSIONS**

All dimensions are in mm. Tolerance is  $\pm 0.25$  mm unless otherwise noted. An epoxy meniscus may extend about 1.5 mm down the leads. Burr around bottom of epoxy may be 0.5 mm max.

# C503C-WAS:





#### NOTES

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the Product Ecology section of the Cree LED website.

#### **Vision Advisory**

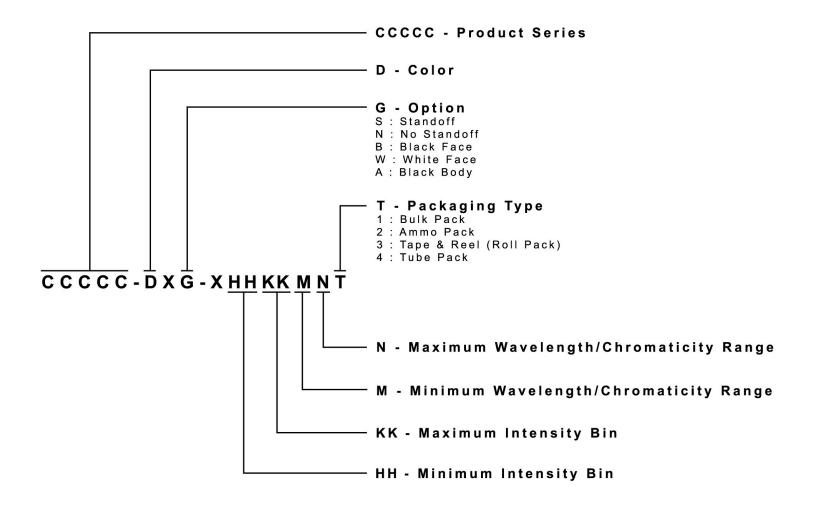
WARNING: Do not look at an exposed lamp in operation. Eye injury can result.

# 

## **KIT NUMBER SYSTEM**

Cree LED lamps are tested and sorted into performance bins. A bin is specified by ranges of color, forward voltage, and brightness. Sorted LEDs are packaged for shipping in various convenient options.

Cree LEDs are sold by order codes in combinations of bins called kits. Order codes are configured in the following manner:

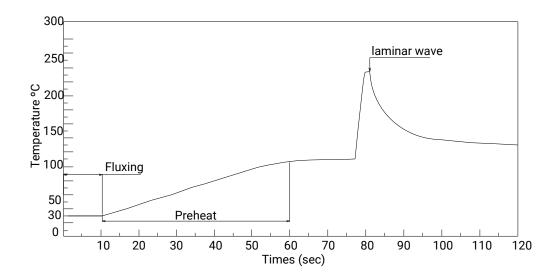


#### **SOLDERING GUIDELINES**

The LED soldering specification is shown below(suitable for both leaded solder & lead-free solder):

Manual Soldering		Solder Dipping		
Soldering iron	35 W max	Preheat	110 °C max	
Temperature 300 °C max	200.00 mov	Preheat time	60 seconds max	
	300 °C max	Solder-bath temperature	260 °C Max	
Soldering time	3 seconds max	Dipping time	5 seconds max	
Position	Not less than 3 mm from the base of the package.	Position	Not less than 3 mm from the base of the package.	

- Manual soldering onto the PCB is not recommended because soldering time is uncontrollable.
- The recommended wave soldering is as below:



- Do not apply any stress to the LED package, particularly when heated.
- Only bottom preheat is suggested & should not preheat on top in order to reduce thermal stress experienced by the LEDs.
- The LEDs must not be re used once they have been extracted from PCB.
- After soldering the LEDs, the package should be protected from mechanical shock or vibration until the LEDs have reached 40 °C or below.
- Precautions must be taken as mechanical stress on the LEDs may be caused by PCB warpage or from the clinching and cutting of the LED leads.
- When it is necessary to clam the LEDs during soldering, it is important to ensure no mechanical stress is exerted on the LEDs.
- Cut the LED lead at normal room temperature. Lead cutting at high temperature may cause failure of the LEDs.
- Please refer to the HB LED Lamp Soldering & Handling document for information about how to use this LED product safely.

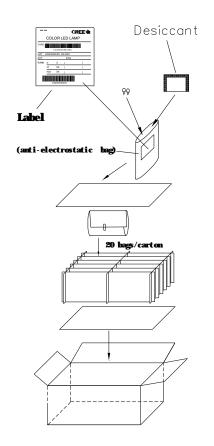


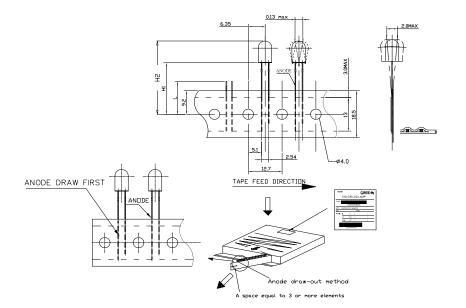
## PACKAGING

- · The LEDs are packed in cardboard boxes after packaging in normal or anti-electrostatic bags.
- · Cardboard boxes will be used to protect the LEDs from mechanical shock during transportation.
- The boxes are not water resistant, and they must be kept away from water and moisture.
- Max 500 pcs per bulk and Max 2500 pcs per ammo.

#### Bulk Pack Packaging Type:

#### Ammo Pack Packaging Type:





# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Cree LED:

 C503C-WAN-CBbDb151
 C503C-WAN-CBbDb152
 C503C-WAN-CBbDb231
 C503C-WAN-CCaDb232
 C503C-WAS 

 CBbDb151
 C503C-WAS-CBbDb152
 C503C-WAS-CBbDb231
 C503C-WAS-CBbDb232
 C503C-WAS-CCaDb231

 C503C-WAS-CCaDb232
 C503C-WAS-CBbDb152
 C503C-WAS-CBbDb231
 C503C-WAS-CBbDb232
 C503C-WAS-CCaDb231